

09-09-2005



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To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies):

Hideharu KOIKE

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies)

Name: Winbond Electronics Corp.

Internal Address:

Street Address:

No. 4, Creation Rd. III
Science-Based Industrial Park

City: Hsinchu

State:

Country: Taiwan ROC

Zip:

Additional name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of conveyance/Execution Date(s):

Execution Date(s): August 12, 2005

☒ Assignment ☐ Merger ☐ Change of Name

☐ Security Agreement ☐ Joint Research Agreement

☐ Government Interest Assignment

☐ Executive Order 9424, Confirmatory License

☐ Other

4. Application or patent number(s):

A. Patent Application No.(s)

NEW

☒ This document is being filed together with a new application.

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Joe McKinney Muncy
BIRCH, STEWART, KOLASCH & BIRCH,
LLP

Internal Address: Atty. Dkt.: 0941-1324PUS1

Street Address: 8110 Gatehouse Rd
Suite 100 East
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City: Falls Church

State: VA Zip: 22040-0747

Phone Number: (703) 205-8026

Fax Number: (703) 205-8050

Email Address: mailroom@bskb.com

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

☐ Authorized to be charged by credit card

☐ Authorized to be charged to deposit account

☒ Enclosed

☐ None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers

Expiration Date

b. Deposit Account Number

Authorized User Name

9. Signature:

Joe McKinney Muncy

Signature

September 2, 2005

Date

Joe McKinney Muncy - 32,834

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

2

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40.00 US

Birch, Stewart, Kolasch & Birch, LLP

KM/nl

ASSIGNMENT

WHEREAS, Hideharu Koike
hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements
as described and set forth in the below identified application for United States Letters Patent:

Title: CMOS BUFFER CIRCUITS AND INTEGRATED CIRCUITS USING THE SAME
Filed: September 2, 2005 Serial No. NEW
Executed on: 2005/08/12

WHEREAS, Winbond Electronics Corp. of No. 4, Creation Rd. III, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.
hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the
said invention and application and in any U.S. Letters Patent which may be granted on the
same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for
good and valuable consideration, receipt of which is hereby acknowledged by Assignor,
Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign
and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their
rights, title and interest in and to the said invention and application and all future
improvements thereon, and in and to any Letters Patent which may hereafter be granted on the
same in the United States, the said interest to be held and enjoyed by said Assignee as fully and
exclusively as it would have been held and enjoyed by said Assignor had this Assignment and
transfer not been made, to the full end and term of any Letters Patent which may be granted
thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion,
reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said
Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said
application and/or applications, execute, verify, acknowledge and deliver all such further
papers, including applications for Letters Patent and for the reissue thereof, and instruments of
assignment and transfer thereof, and will perform such other acts as Assignee lawfully may
request, to obtain or maintain Letters Patent for said invention and improvement, and to vest
title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the
date(s) indicated.

Hideharu Koike
Hideharu Koike

Aug. 12, 2005
Date